



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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1.5A SURFACE MOUNT GLASS PASSIVATED RECTIFIER
Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 50A Peak
- Ideally Suited for Automated Assembly
- **Lead Free Finish/RoHS Compliant (Note 1)**
- **Green Molding Compound (No Halogen and Antimony) (Note 2)**

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 ^{Ⓔ3}
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (approximate)
SMB 0.093 grams (approximate)



Top View



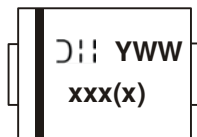
Bottom View

Ordering Information (Note 3)

| Part Number | Case | Packaging |
|-------------|------|------------------|
| S2xA-13-F | SMA | 5000/Tape & Reel |
| S2x-13-F | SMB | 3000/Tape & Reel |

*x = Device type, e.g. S2AA-13-F (SMA package); S2A-13-F (SMB package).

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
 3. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information


- xxx = Product type marking code, ex: S2A (SMB package)
- xxxx = Product type marking code, ex: S2AA (SMA package)
- Ⓛ: = Manufacturers' code marking
- YWW = Date code marking
- Y = Last digit of year (ex: 2 for 2002)
- WW = Week code (01 to 53)

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

| Characteristic | Symbol | S2 A/AA | S2 B/BA | S2 D/DA | S2 G/GA | S2 J/JA | S2 K/KA | S2 M/MA | Unit |
|--|--------------|---------|---------|---------|---------|---------|---------|---------|------|
| Peak Repetitive Reverse Voltage | V_{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Working Peak Reverse Voltage | V_{RWM} | | | | | | | | |
| DC Blocking Voltage | V_R | | | | | | | | |
| RMS Reverse Voltage | $V_{R(RMS)}$ | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Average Rectified Output Current @ $T_T = 100^\circ\text{C}$ | $I_{(AV)}$ | 1.5 | | | | | | | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I_{FSM} | 50 | | | | | | | A |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------------|--------------------|
| Typical Thermal Resistance, Junction to Terminal (Note 4) | $R_{\theta JT}$ | 20 | $^\circ\text{C/W}$ |
| Operating and Storage Temperature Range | T_J, T_{STG} | -65 to +150 | $^\circ\text{C}$ |

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|--|----------|-------|---------------|
| Forward Voltage @ $I_F = 1.5\text{A}$ | V_{FM} | 1.15 | V |
| Peak Reverse Current @ $T_A = 25^\circ\text{C}$ | I_{RM} | 5.0 | μA |
| at Rated DC Blocking Voltage @ $T_A = 125^\circ\text{C}$ | | 125 | |
| Typical Total Capacitance (Note 5) | C_T | 20 | pF |

Notes: 4. Thermal Resistance Junction to Terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
5. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

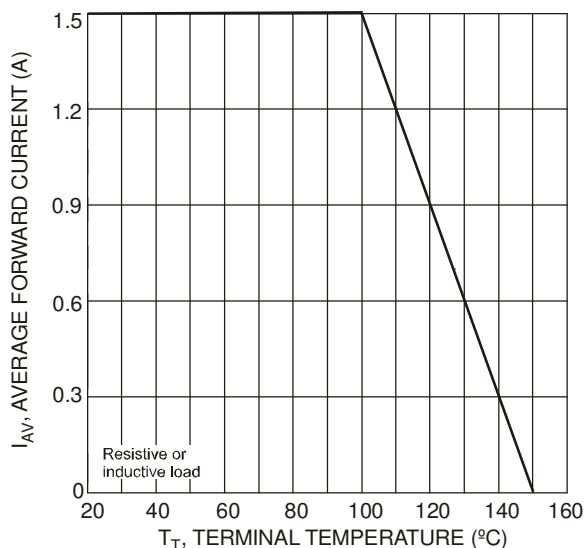


Fig. 1 Forward Current Derating Curve

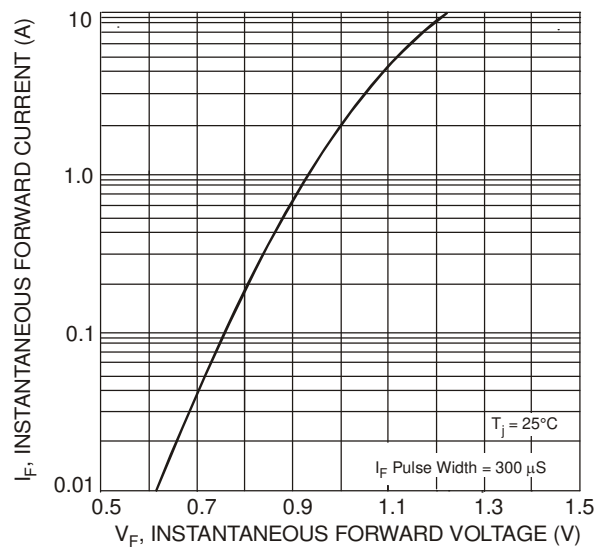


Fig. 2 Typical Forward Characteristics

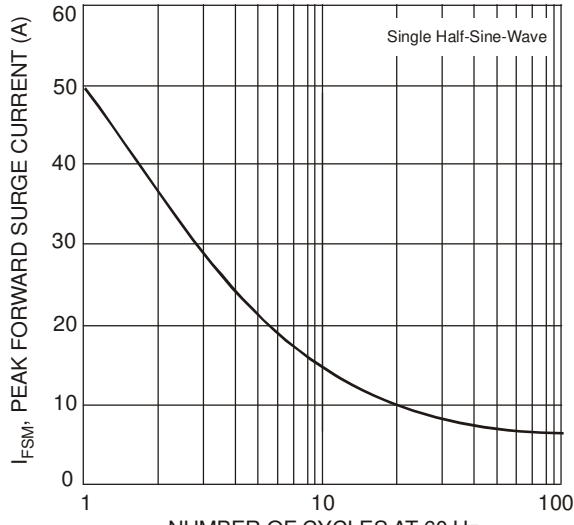


Fig. 3 Forward Surge Current Derating Curve

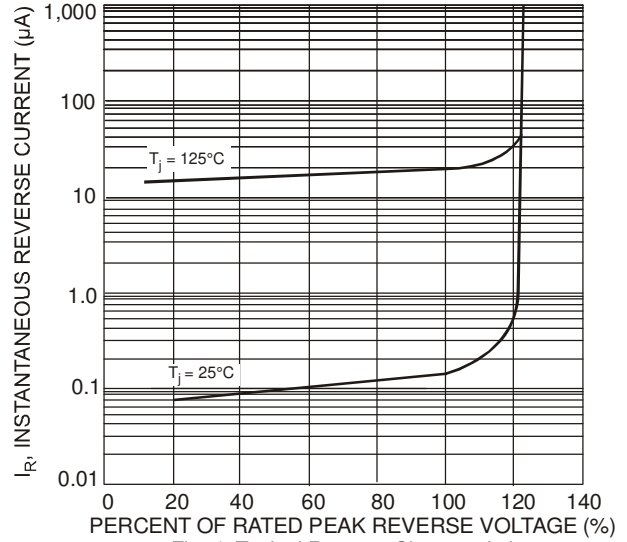
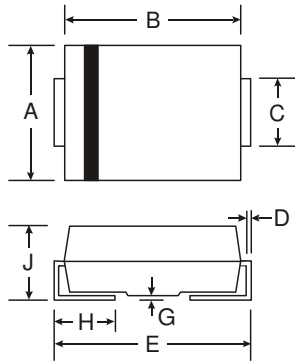


Fig. 4 Typical Reverse Characteristics

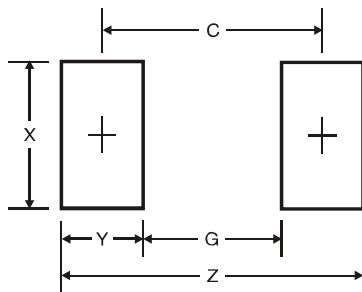
Package Outline Dimensions



| SMA | | |
|----------------------|------|------|
| Dim | Min | Max |
| A | 2.29 | 2.92 |
| B | 4.00 | 4.60 |
| C | 1.27 | 1.63 |
| D | 0.15 | 0.31 |
| E | 4.80 | 5.59 |
| G | 0.05 | 0.20 |
| H | 0.76 | 1.52 |
| J | 2.01 | 2.30 |
| All Dimensions in mm | | |

| SMB | | |
|----------------------|------|------|
| Dim | Min | Max |
| A | 3.30 | 3.94 |
| B | 4.06 | 4.57 |
| C | 1.96 | 2.21 |
| D | 0.15 | 0.31 |
| E | 5.00 | 5.59 |
| G | 0.05 | 0.20 |
| H | 0.76 | 1.52 |
| J | 2.00 | 2.50 |
| All Dimensions in mm | | |

Suggested Pad Layout



| SMA Dimensions | Value (in mm) |
|----------------|---------------|
| Z | 6.5 |
| G | 1.5 |
| X | 1.7 |
| Y | 2.5 |
| C | 4.0 |

| SMB Dimensions | Value (in mm) |
|----------------|---------------|
| Z | 6.7 |
| G | 1.8 |
| X | 2.3 |
| Y | 2.5 |
| C | 4.3 |

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